PATENT ASSIGNMENT

Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:		NEW ASSIGNMENT	
NATURE OF CONVEYANCE:		ASSIGNMENT	
CONVEYING PARTY	DATA		
N		Name	Execution Date
Jhon Jhy LIAW			12/04/2009
RECEIVING PARTY I	DATA		
Name:	Taiwan Semicono	luctor Manufacturing Co., Ltd.	
Street Address:	No. 8, Li-Hsin Ro	ad 6	
Internal Address:	Science-Based In	dustrial Park	
City:	Hsin-Chu		
State/Country:			
Postal Code:	300-77		
	RS Total: 1		
Property Type			
		Number	
Property T Application Number:		Number 51667	
	126		
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Serial No. 12/651,667 filed 01/04/2010

ATTORNEY DOCKET NO.: 2009.0421CIP/1085.624

ASSIGNMENT AND AGREEMENT

For value received, I, Jhon Jhy Liaw, hereby transfer to Taiwan Semiconductor Manufacturing Co., Ltd., with its principal place of business located at No. 8, Li-Hsin Road 6, Science-Based Industrial Park, Hsin-Chu, Taiwan 300-77, Republic of China, and its successors, assigns and legal representatives, the entire right, title and interest, for the United States of America, in and to certain inventions related to CELL STRUCTURE FOR DUAL PORT SRAM described in a non-provisional application and under any and all Letters Patent and any divisions, continuations, continuations-in-part, reexamination certificates, reissues, and extensions thereof, or claiming priority therefrom that may be granted in the United States for said inventions; and we also concurrently hereby sell, assign and transfer to Taiwan Semiconductor Manufacturing Co., Ltd. the entire right, title and interest in and to said inventions for all countries foreign to the United States, including all rights of priority arising from the application aforesaid, and all the rights and privileges under any and all forms of protection, including Letters Patent, that may be granted in said countries foreign to the United States for said inventions.

I authorize Taiwan Semiconductor Manufacturing Co., Ltd. to make application for such protection in its own name and maintain such protection in any and all countries foreign to the United States, and to invoke and claim for any application for patent or other form of protection for said inventions, without further authorization from me, any and all benefits, including the right of priority provided by any and all treaties, conventions, or agreements.

I hereby consent that a copy of this assignment shall be deemed a full legal and formal equivalent of any document which may be required in any country in proof of the right of Taiwan Semiconductor Manufacturing Co., Ltd. to apply for patent or other form of protection for said inventions and to claim the aforesaid benefit of the right of priority.

I request that any and all patents for said inventions be issued to Taiwan Semiconductor Manufacturing Co., Ltd. in the United States and in all countries foreign to the United States, or to such nominees as Taiwan Semiconductor Manufacturing Co., Ltd. may designate.

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PATENT REEL: 023735 FRAME: 0837

ATTORNEY DOCKET NO.: 2009.0421CIP/1085.624

I agree that, when requested, I shall, without charge to Taiwan Semiconductor Manufacturing Co., Ltd. but at its expense, sign all papers, and do all acts which may be necessary, desirable or convenient in connection with said applications, patents, or other forms of protection.

Dated: 17 2004

Thin Thy LEar Jhon Jhy Liaw

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Residence:

12 F., No. 38-21, Lane 72, Kuo Haw 2nd Street, Hsin-Chu, Taiwan, R.O.C.

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RECORDED: 01/05/2010